

SURFACE MOUNT DISPLAY

APSA03-41SURKWA

HYPER RED

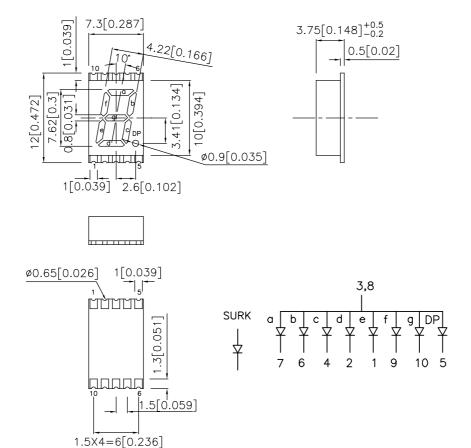
Features

- •0.3 INCH DIGIT HEIGHT.
- •LOW CURRENT OPERATION.
- •EXCELLENT CHARACTER APPEARANCE.
- •I.C. COMPATIBLE.
- •MECHANICALLY RUGGED.
- •GRAY FACE, WHITE SEGMENT.
- •PACKAGE: 1100PCS/REEL.

Description

The Hyper Red source color devices are made with DH InGaAIP on GaAs substrate Light Emitting Diode.

Package Dimensions & Internal Circuit Diagram



Notes

- 1. All dimensions are in millimeters (inches), Tolerance is $\pm 0.25(0.01")$ unless otherwise noted.
- 2. Specifications are subject to change without notice.

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 REV NO: V.5
 DATE:JUN/15/2005
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 APPROVED: J. Lu
 CHECKED: Joe Lee
 DRAWN: W.J.ZHU
 ERP:1351000027

Selection Guide

Part No.	Dice	Lens Type	lv (ucd) @ 10mA		@ 10m/A		Description	
			Min.	Тур.				
APSA03-41SURKWA	HYPER RED (InGaAIP)	WHITE DIFFUSED	3000	15257	Common Anode, Rt. Hand Decimal.			

Electrical / Optical Characteristics at Ta=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Hyper Red	650		nm	IF=20mA
λD	Dominant Wavelength	Hyper Red	635		nm	Ir=20mA
Δλ1/2	Spectral Line Half-width	Hyper Red	28		nm	IF=20mA
С	Capacitance	Hyper Red	35		pF	VF=0V;f=1MHz
VF	Forward Voltage	Hyper Red	1.95	2.5	V	IF=20mA
lr	Reverse Current	Hyper Red		10	uA	VR = 5V

Absolute Maximum Ratings at Ta=25°C

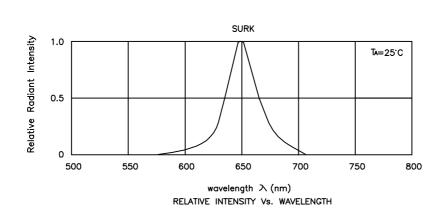
Parameter	Hyper Red	Units	
Power dissipation	170	mW	
DC Forward Current	30	mA	
Peak Forward Current [1]	185	mA	
Reverse Voltage	5	V	
Operating/Storage Temperature	-40°C To +85°C		

Note

1. 1/10 Duty Cycle, 0.1ms Pulse Width.

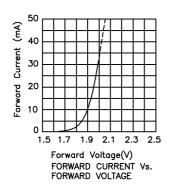
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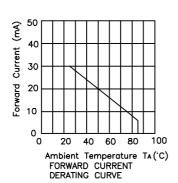
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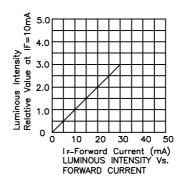


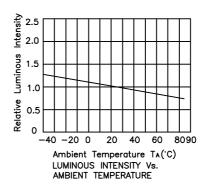
Hyper Red

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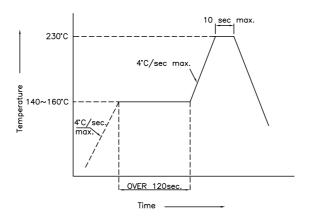


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APSA03-41SURKWA SMT Reflow Soldering Instructions

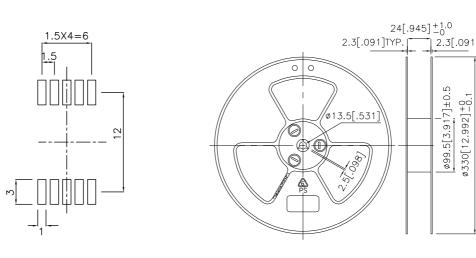
Number of reflow process shall be 2 times or less and cooling process to normal temperature is required between first and second soldering process.



Recommended Soldering Pattern

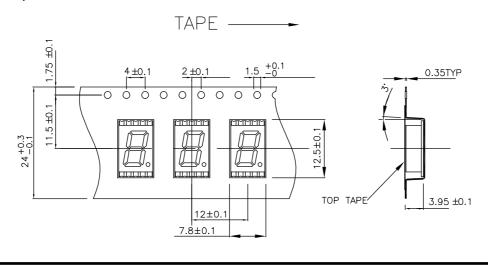
(Units: mm)

Reel Dimension

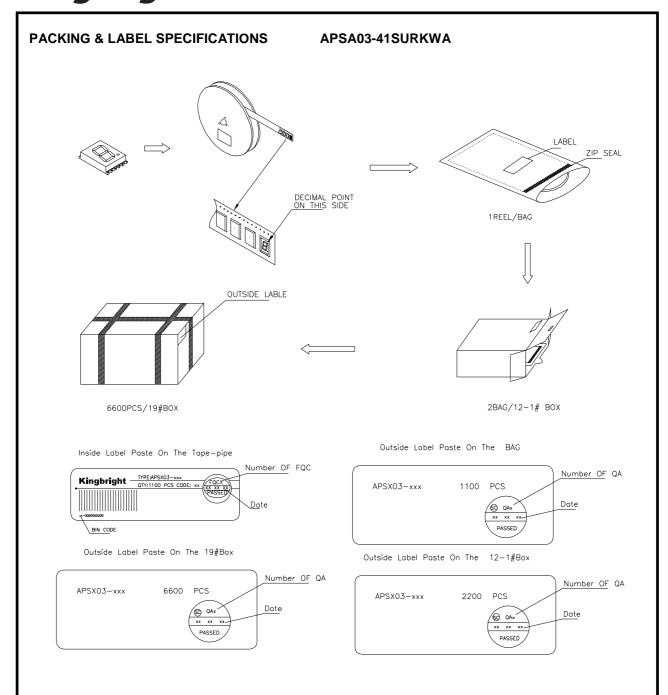


Tape Specifications

(Units: mm)



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Remarks:

If special sorting is required (e.g. binning based on forward voltage, luminous intensity, or wavelength),

the typical accuracy of the sorting process is as follows:

- 1. Wavelength: +/-1nm
- 2. Luminous Intensity: +/-15%
- 3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.

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